- Function and Pinout Compatible With FCT and F Logic
- 25-Ω Output Series Resistors to Reduce Transmission-Line Reflection Noise
- Reduced V_{OH} (Typically = 3.3 V) Version of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- I_{off} Supports Partial-Power-Down Mode Operation
- Matched Rise and Fall Times
- Fully Compatible With TTL Input and Output Logic Levels
- ESD Protection Exceeds JESD 22
 2000-V Human-Body Model (A114-A)
 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- 3-State Outputs
- 12-mA Output Sink Current
 15-mA Output Source Current
- Edge-Triggered D-Type Inputs
- 250-MHz Typical Switching Rate

description

The CY74FCT2574T is a high-speed, low-power, octal D-type flip-flop featuring separate D-type inputs for each flip-flop. On-chip termination resistors at the outputs reduce system noise caused by reflections. The CY74FCT2574T can replace the CY74FCT574T to reduce noise in an existing design. This device has 3-state outputs for bus-oriented applications. A buffered clock (CP) and output-enable (\overline{OE}) inputs are common to all flip-flops. The CY74FCT2574T is identical to the CY74FCT2374T, except that on the CY74FCT2574T all outputs are on one side of the package and all inputs are on the other side. The flip-flops in the CY74FCT2574T store the state of their individual D inputs that meet the setup-time and hold-time requirements on the low-to-high CP transition. When \overline{OE} is low, the contents of the flip-flops are available at the outputs. When \overline{OE} is high, the outputs are in the high-impedance state. The state of \overline{OE} does not affect the state of the flip-flops.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



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[1	20] V _{CC}
Δ	2 3	19] O ₀
٥	3	18] O ₁
٥	4	17] O ₂
٥	5	16] V _{CC}] O ₀] O ₁] O ₂] O ₂] O ₃] O ₄] O ₅] O ₆] O ₇] CP
٥	6	15] O ₄
٥	7	14] O ₅
٥	8	13] O ₆
۵	9	12] 0 ₇
Δ	10	11] CP

Q OR SO PACKAGE (TOP VIEW)

OF

 D_0

D₁

 D_2

 D_3

 D_4

 D_5

 D_6

D₇ GND

T _A PACKAGE		KAGE [†]	SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING					
	QSOP – Q	Tape and reel	5.2	CY74FCT2574CTQCT	FCT2574C					
	SOIC – SO	Tube	5.2	CY74FCT2574CTSOC	FCT2574C					
–40°C to 85°C		Tape and reel	5.2	CY74FCT2574CTSOCT	10123740					
-40 C 10 85 C	QSOP – Q	Tape and reel	6.5	CY74FCT2574ATQCT	FCT2574A					
	SOIC – SO	Tube	10	CY74FCT2574TSOC	FCT2574					
	3010 - 30	Tape and reel	10	CY74FCT2574TSOCT	FG12374					

ORDERING INFORMATION

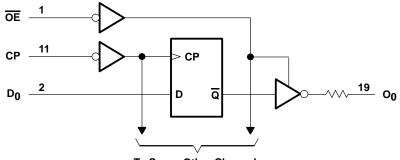
[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

	INPUTS	OUTPUT	
D	СР	OE	0
н	Ŷ	L	Н
L	Ŷ	L	L
Х	Х	Н	Z

H = High logic level, L = Low logic level, X = Don't care, Z = High-impedance state, \uparrow = Low-to-high clock transition

logic diagram (positive logic)



To Seven Other Channels



CY74FCT2574T **8-BIT REGISTER** WITH 3-STATE OUTPUTS

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absolute maximum rating over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range to ground potential	–0.5 V to 7 V
DC input voltage range	\ldots -0.5 V to 7 V
DC output voltage range	$\ldots~$ –0.5 V to 7 V
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, θ_{JA} (see Note 1): Q package	68°C/W
SO package	58°C/W
Ambient temperature range with power applied, T _A	. –65°C to 135°C
Storage temperature range, T _{stg}	. –65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
ЮН	High-level output current			-15	mA
IOL	Low-level output current			12	mA
Т _А	Operating free-air temperature	-40		85	°C

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	түр†	MAX	UNIT	
VIK	V _{CC} = 4.75 V,	I _{IN} = -18 mA			-0.7	-1.2	V	
VOH	V _{CC} = 4.75 V,	I _{OH} = -15 mA		2.4	3.3		V	
VOL	V _{CC} = 4.75 V,	I _{OL} = 12 mA			0.3	0.55	V	
ROUT	V _{CC} = 4.75 V,	I _{OL} = 12 mA		20	25	40	Ω	
V _{hys}	All inputs				0.2		V	
lj	V _{CC} = 5.25 V,	$V_{IN} = V_{CC}$				5	μA	
ЧН	V _{CC} = 5.25 V,	V _{IN} = 2.7 V				±1	μA	
۱ _{IL}	V _{CC} = 5.25 V,	V _{IN} = 0.5 V				±1	μA	
IOZH	V _{CC} = 5.25 V,	V _{OUT} = 2.7 V				10	μA	
IOZL	V _{CC} = 5.25 V,	V _{OUT} = 0.5 V				-10	μA	
los‡	V _{CC} = 5.25 V,	V _{OUT} = 0 V		-60	-120	-225	mA	
l _{off}	$V_{CC} = 0 V,$	V _{OUT} = 4.5 V				±1	μA	
ICC	V _{CC} = 5.25 V,	$V_{IN} \le 0.2 V$,	$V_{IN} \ge V_{CC} - 0.2 V$		0.1	0.2	mA	
∆ICC	V _{CC} = 5.25 V, V _{IN} =	3.4 V§, $f_1 = 0$, Outputs op	en		0.5	2	mA	
ICCD		ts open, One input switchin $2 \text{ V or } \text{V}_{IN} \ge \text{V}_{CC} - 0.2 \text{ V}$	ng at 50% duty cycle,		0.06	0.12	mA MH	
	V _{CC} = 5.25 V,	One bit switching at f ₁ = 5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{V}$		0.7	1.4		
IC#	Outputs open,	at 50% duty cycle	$V_{IN} = 3.4 \text{ V or GND}$		1.2 3.4		mA	
'C"		Eight bits switching at f ₁ = 2.5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$		1.6	3.2	111/1	
		at 50% duty cycle	$V_{IN} = 3.4 \text{ V or GND}$		3.9	12.2	1	
Ci					5	10	pF	
Co					9	12	pF	

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

‡Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

§ Per TTL-driven input (V_{IN} = 3.4 V); all other inputs at V_{CC} or GND

¶ This parameter is derived for use in total power-supply calculations.

 $^{\#}I_{C}$ $= I_{CC} + \Delta I_{CC} \times D_H \times N_T + I_{CCD} (f_0/2 + f_1 \times N_1)$

Where:

- IC = Total supply current
- ICC = Power-supply current with CMOS input levels
- ΔI_{CC} = Power-supply current for a TTL high input (VIN = 3.4 V)
- D_H = Duty cycle for TTL inputs high
- = Number of TTL inputs at D_H NΤ

I_{CCD} = Dynamic current caused by an input transition pair (HLH or LHL)

- fo = Clock frequency for registered devices, otherwise zero
- = Input signal frequency f1
- = Number of inputs changing at f1 N_1
- All currents are in milliamperes and all frequencies are in megahertz.

I Values for these conditions are examples of the I_{CC} formula.



timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

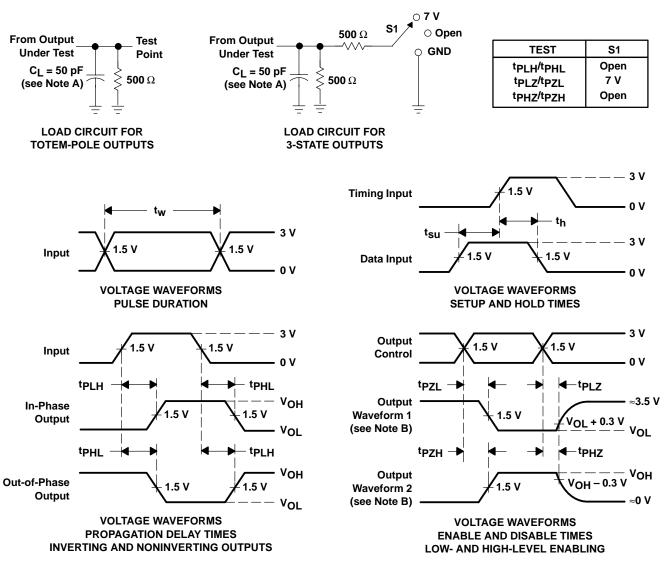
		CY74FCT2574T		CY74FCT2574AT		CY74FCT2574CT		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
tw	Pulse duration, CP	7		5		4		ns
t _{su}	Setup time, data before CP1	2		2		1.5		ns
t _h	Hold time, data after CP↑	1.5		1.5		1		ns

switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CY74FCT2574T		CY74FCT2574AT		CY74FCT2574CT		UNIT
PARAMETER			MIN	MAX	MIN	MAX	MIN	MAX	
^t PLH	СР	0	2	10	2	6.5	2	5.2	ns
^t PHL			2	10	2	6.5	2	5.2	
^t PZH	ŌĒ	0	1.5	12.5	1.5	6.5	1.5	6.2	
^t PZL			1.5	12.5	1.5	6.5	1.5	6.2	ns
^t PHZ	ŌĒ	DE O	1.5	8	1.5	5.5	1.5	5	20
^t PLZ			1.5	8	1.5	5.5	1.5	5	ns



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C₁ includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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